A7832206 | SFP+, 10G, Bi-Di, 1330nmTx /1270nmRx, up to 40 km



Small form factor pluggable+ BiDi Module, 10G BASE, CWDM, Singlemode, TAA compliant, up to 40 km

- Single LC connector
- Hot-pluggable SFP footprint
- Uncooled DFB laser transmitter
- RoHS compliant and Lead Free
- Up to 40Km on 9/125um SMF
- Metal enclosure for lower EMI
- Commercial and industrial operating temperature optional
- Trade Agreements Act (TAA) compliant

Optical module
BiDi SFP
LC/UPC
Detailed Product Specifications are available. Please contact your local ANDREW representative.
12 mm 0.472 in
13.9 mm 0.547 in
56.5 mm 2.224 in
9/125 μm, singlemode
6 dBm
1 dBm
±3dB / ±3dB
1270 nm (Rx) 1330 nm (Tx)
-13 dBm
+1 dBm



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Environmental Specifications

Operating Temperature	0 °C to +70 °C (+32 °F to +158 °F)
Packaging and Weights	
Height, packed	20 mm 0.787 in
Width, packed	105 mm 4.134 in
Depth, packed	65 mm 2.559 in
Packaging quantity	1
Weight, gross	0.036 kg 0.079 lb
Weight, net	0.022 kg 0.049 lb

Page 2 of 2



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